

# Hex 3-State Noninverting Buffer with Common Enables

## High-Performance Silicon-Gate CMOS

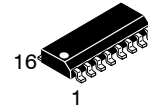
### MC74HC365A, MC74HCT365A

The MC74HC365A/MC74HCT365A is identical in pinout to the LS365. The MC74HC365A inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs. The MC74HCT365A inputs are compatible with LSTTL outputs.

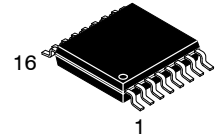
This device is a high-speed hex buffer with 3-state outputs and two common active-low Output Enables. When either of the enables is high, the buffer outputs are placed into high-impedance states. The HC365A, HCT365A has noninverting outputs.

#### Features

- Output Drive Capability: 15 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V (HC), 4.5 to 5.5 V (HCT)
- Low Input Current: 1.0  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 90 FETs or 22.5 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



SOIC-16  
D SUFFIX  
CASE 751B

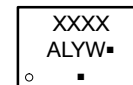
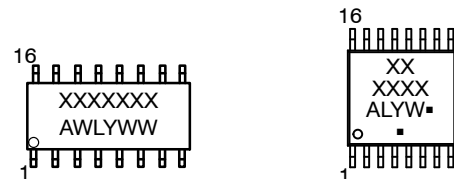


TSSOP-16  
DT SUFFIX  
CASE 948F



QFN16  
MN SUFFIX  
CASE 485AW

#### MARKING DIAGRAMS



- A = Assembly Location  
 WL, L = Wafer Lot  
 YY, Y = Year  
 WW, W = Work Week  
 G or ■ = Pb-Free Package  
 (Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

# MC74HC365A, MC74HCT365A

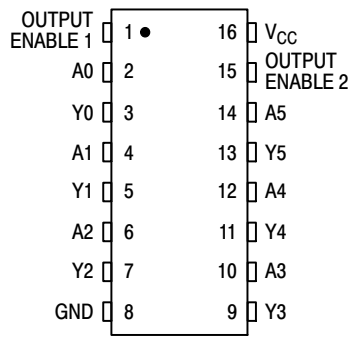


Figure 1. Pin Assignment

## FUNCTION TABLE

| Inputs   |          |   | Output |
|----------|----------|---|--------|
| Enable 1 | Enable 2 | A | Y      |
| L        | L        | L | L      |
| L        | L        | H | H      |
| H        | X        | X | Z      |
| X        | H        | X | Z      |

X = don't care

Z = high impedance

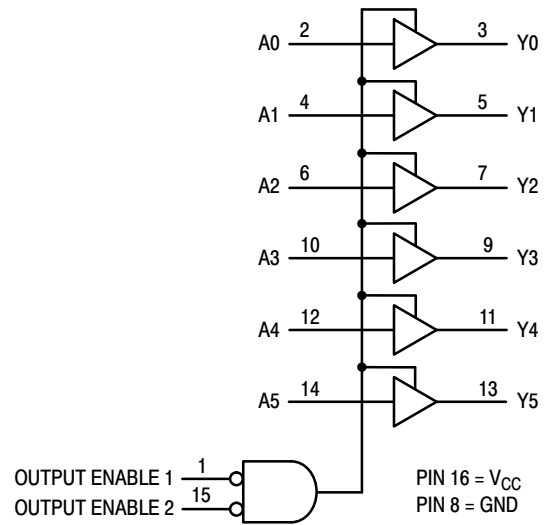


Figure 2. Logic Diagram

# MC74HC365A, MC74HCT365A

## MAXIMUM RATINGS

| Symbol        | Parameter                                                    | Value                                    | Unit                      |
|---------------|--------------------------------------------------------------|------------------------------------------|---------------------------|
| $V_{CC}$      | DC Supply Voltage                                            | -0.5 to +6.5                             | V                         |
| $V_{IN}$      | DC Input Voltage                                             | -0.5 to $V_{CC} + 0.5$                   | V                         |
| $V_{OUT}$     | DC Output Voltage                                            | -0.5 to $V_{CC} + 0.5$                   | V                         |
| $I_{IN}$      | DC Input Current, per Pin                                    | $\pm 20$                                 | mA                        |
| $I_{OUT}$     | DC Output Current, per Pin                                   | $\pm 25$                                 | mA                        |
| $I_{CC}$      | DC Supply Current, $V_{CC}$ and GND Pins                     | $\pm 50$                                 | mA                        |
| $I_{IK}$      | Input Clamp Current ( $V_{IN} < 0$ or $V_{IN} > V_{CC}$ )    | $\pm 20$                                 | mA                        |
| $I_{OK}$      | Output Clamp Current ( $V_{OUT} < 0$ or $V_{OUT} > V_{CC}$ ) | $\pm 20$                                 | mA                        |
| $T_{STG}$     | Storage Temperature                                          | -65 to +150                              | °C                        |
| $T_L$         | Lead Temperature, 1 mm from Case for 10 Seconds              | 260                                      | °C                        |
| $T_J$         | Junction Temperature Under Bias                              | $\pm 150$                                | °C                        |
| $\theta_{JA}$ | Thermal Resistance (Note 1)                                  | SOIC-16<br>QFN16<br>TSSOP-16             | 126<br>118<br>159<br>°C/W |
| $P_D$         | Power Dissipation in Still Air at 25°C                       | SOIC-16<br>QFN16<br>TSSOP-16             | 995<br>1062<br>787<br>mW  |
| MSL           | Moisture Sensitivity                                         | Level 1                                  | -                         |
| $F_R$         | Flammability Rating                                          | Oxygen Index: 28 to 34                   | UL 94 V-0 @ 0.125 in      |
| $V_{ESD}$     | ESD Withstand Voltage (Note 2)                               | Human Body Model<br>Charged Device Model | 2000<br>N/A<br>V          |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
2. HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|--------|-----------|-----|-----|------|
|--------|-----------|-----|-----|------|

### MC74HC

|                   |                                   |                                                                              |                                |    |
|-------------------|-----------------------------------|------------------------------------------------------------------------------|--------------------------------|----|
| $V_{CC}$          | DC Supply Voltage                 | 2.0                                                                          | 6.0                            | V  |
| $V_{IN}, V_{OUT}$ | DC Input, Output Voltage (Note 3) | 0                                                                            | $V_{CC}$                       | V  |
| $T_A$             | Operating Free-Air Temperature    | -55                                                                          | +125                           | °C |
| $t_r, t_f$        | Input Rise or Fall Time           | $V_{CC} = 2.0$ V<br>$V_{CC} = 3.0$ V<br>$V_{CC} = 4.5$ V<br>$V_{CC} = 6.0$ V | 0<br>1000<br>600<br>500<br>400 | ns |

### MC74HCT

|                   |                                   |     |          |    |
|-------------------|-----------------------------------|-----|----------|----|
| $V_{CC}$          | DC Supply Voltage                 | 4.5 | 5.5      | V  |
| $V_{IN}, V_{OUT}$ | DC Input, Output Voltage (Note 3) | 0   | $V_{CC}$ | V  |
| $T_A$             | Operating Free-Air Temperature    | -55 | +125     | °C |
| $t_r, t_f$        | Input Rise or Fall Time           | 0   | 500      | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

# MC74HC365A, MC74HCT365A

## DC ELECTRICAL CHARACTERISTICS (MC74HC365A)

| Symbol          | Parameter                                      | Test Conditions                                                                                                                     | V <sub>CC</sub><br>V     | Guaranteed Limit             |                              |                              | Unit |
|-----------------|------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|--------------------------|------------------------------|------------------------------|------------------------------|------|
|                 |                                                |                                                                                                                                     |                          | −55 to<br>25°C               | ≤ 85°C                       | ≤ 125°C                      |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage               | V <sub>out</sub> = V <sub>CC</sub> − 0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                                           | 2.0<br>3.0<br>4.5<br>6.0 | 1.5<br>2.1<br>3.15<br>4.2    | 1.5<br>2.1<br>3.15<br>4.2    | 1.5<br>2.1<br>3.15<br>4.2    | V    |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage                | V <sub>out</sub> = 0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                                                             | 2.0<br>3.0<br>4.5<br>6.0 | 0.50<br>0.90<br>1.35<br>1.80 | 0.50<br>0.90<br>1.35<br>1.80 | 0.50<br>0.90<br>1.35<br>1.80 | V    |
| V <sub>OH</sub> | Minimum High-Level Output Voltage              | V <sub>in</sub> = V <sub>IH</sub><br> I <sub>out</sub>   ≤ 20 μA                                                                    | 2.0<br>4.5<br>6.0        | 1.9<br>4.4<br>5.9            | 1.9<br>4.4<br>5.9            | 1.9<br>4.4<br>5.9            | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub>  I <sub>out</sub>   ≤ 3.6 mA<br> I <sub>out</sub>   ≤ 6.0 mA<br> I <sub>out</sub>   ≤ 7.8 mA      | 3.0<br>4.5<br>6.0        | 2.48<br>3.98<br>5.48         | 2.34<br>3.84<br>5.34         | 2.20<br>3.70<br>5.20         |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> = V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA                                                                    | 2.0<br>4.5<br>6.0        | 0.1<br>0.1<br>0.1            | 0.1<br>0.1<br>0.1            | 0.1<br>0.1<br>0.1            | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IL</sub>  I <sub>out</sub>   ≤ 3.6 mA<br> I <sub>out</sub>   ≤ 6.0 mA<br> I <sub>out</sub>   ≤ 7.8 mA      | 3.0<br>4.5<br>6.0        | 0.26<br>0.26<br>0.26         | 0.33<br>0.33<br>0.33         | 0.40<br>0.40<br>0.40         |      |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> = V <sub>CC</sub> or GND                                                                                            | 6.0                      | ±0.1                         | ±1.0                         | ±1.0                         | μA   |
| I <sub>OZ</sub> | Maximum Three-State Leakage Current            | Output in High-Impedance State<br>V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub><br>V <sub>out</sub> = V <sub>CC</sub> or GND | 6.0                      | ±0.5                         | ±5.0                         | ±10                          | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> = V <sub>CC</sub> or GND<br>I <sub>out</sub> = 0 μA                                                                 | 6.0                      | 4                            | 40                           | 160                          | μA   |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# MC74HC365A, MC74HCT365A

## AC ELECTRICAL CHARACTERISTICS (MC74HC365A)

| Symbol                                 | Parameter                                                                  | V <sub>CC</sub><br>V     | Guaranteed Limit       |                        |                        | Unit |
|----------------------------------------|----------------------------------------------------------------------------|--------------------------|------------------------|------------------------|------------------------|------|
|                                        |                                                                            |                          | −55 to<br>25°C         | ≤ 85°C                 | ≤ 125°C                |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A to Output Y<br>(Figures 3 and 4)        | 2.0<br>3.0<br>4.5<br>6.0 | 120<br>60<br>24<br>20  | 150<br>75<br>30<br>26  | 180<br>90<br>36<br>31  | ns   |
| t <sub>PLZ</sub> ,<br>t <sub>PHZ</sub> | Maximum Propagation Delay, Output Enable to Output Y<br>(Figures 3 and 4)  | 2.0<br>3.0<br>4.5<br>6.0 | 220<br>110<br>44<br>37 | 275<br>140<br>55<br>47 | 330<br>170<br>66<br>56 | ns   |
| t <sub>PZL</sub> ,<br>t <sub>PZH</sub> | Maximum Propagation Delay, Output Enable to Output Y<br>(Figures 3 and 4)  | 2.0<br>3.0<br>4.5<br>6.0 | 220<br>110<br>44<br>37 | 275<br>140<br>55<br>47 | 330<br>170<br>66<br>56 | ns   |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 3 and 4)            | 2.0<br>3.0<br>4.5<br>6.0 | 60<br>22<br>12<br>10   | 75<br>28<br>15<br>13   | 90<br>34<br>18<br>15   | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance                                                  | –                        | 10                     | 10                     | 10                     | pF   |
| C <sub>out</sub>                       | Maximum Three-State Output Capacitance<br>(Output in High-Impedance State) | –                        | 15                     | 15                     | 15                     | pF   |

| C <sub>PD</sub> | Power Dissipation Capacitance (Per Buffer)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V | pF |
|-----------------|---------------------------------------------|-----------------------------------------|----|
|                 |                                             | 60                                      |    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

\*Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

# MC74HC365A, MC74HCT365A

## DC ELECTRICAL CHARACTERISTICS (MC74HCT365A)

| Symbol          | Parameter                                      | Test Conditions                                                                                                                     | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|-----------------|------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|----------------------|------------------|--------|---------|------|
|                 |                                                |                                                                                                                                     |                      | –55 to 25°C      | ≤ 85°C | ≤ 125°C |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage               | V <sub>out</sub> = V <sub>CC</sub> – 0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                                           | 4.5 to 5.5           | 2.0              | 2.0    | 2.0     | V    |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage                | V <sub>out</sub> = 0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                                                             | 4.5 to 5.5           | 0.8              | 0.8    | 0.8     | V    |
| V <sub>OH</sub> | Minimum High-Level Output Voltage              | V <sub>in</sub> = V <sub>IH</sub><br> I <sub>out</sub>   ≤ 20 μA                                                                    | 4.5                  | 4.4              | 4.4    | 4.4     | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub>  I <sub>out</sub>   ≤ 6.0 mA                                                                      | 4.5                  | 3.98             | 3.84   | 3.70    |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> = V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA                                                                    | 4.5                  | 0.1              | 0.1    | 0.1     | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IL</sub>  I <sub>out</sub>   ≤ 6.0 mA                                                                      | 4.5                  | 0.26             | 0.33   | 0.40    |      |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> = V <sub>CC</sub> or GND                                                                                            | 4.5                  | ±0.1             | ±1.0   | ±1.0    | μA   |
| I <sub>OZ</sub> | Maximum Three-State Leakage Current            | Output in High-Impedance State<br>V <sub>in</sub> = V <sub>IL</sub> or V <sub>IH</sub><br>V <sub>out</sub> = V <sub>CC</sub> or GND | 4.5                  | ±0.5             | ±5.0   | ±10     | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> = V <sub>CC</sub> or GND<br>I <sub>out</sub> = 0 μA                                                                 | 4.5                  | 4                | 40     | 160     | μA   |

| ΔI <sub>CC</sub> | Additional Quiescent Supply Current | V <sub>in</sub> = 2.4 V, Any One Input<br>V <sub>in</sub> = V <sub>CC</sub> or GND, Other Inputs<br>I <sub>out</sub> = 0 μA | 5.5 | ≥ –55°C | 25 to 125°C | mA |
|------------------|-------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|-----|---------|-------------|----|
|                  |                                     |                                                                                                                             |     | 2.9     | 2.4         |    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## AC ELECTRICAL CHARACTERISTICS (MC74HCT365A)

| Symbol                                 | Parameter                                                                  | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|----------------------------------------|----------------------------------------------------------------------------|----------------------|------------------|--------|---------|------|
|                                        |                                                                            |                      | –55 to 25°C      | ≤ 85°C | ≤ 125°C |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A to Output Y<br>(Figures 3 and 4)        | 4.5                  | 24               | 30     | 36      | ns   |
| t <sub>PLZ</sub> ,<br>t <sub>PHZ</sub> | Maximum Propagation Delay, Output Enable to Output Y<br>(Figures 3 and 4)  | 4.5                  | 44               | 55     | 66      | ns   |
| t <sub>PZL</sub> ,<br>t <sub>PZH</sub> | Maximum Propagation Delay, Output Enable to Output Y<br>(Figures 3 and 4)  | 4.5                  | 44               | 55     | 66      | ns   |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 3 and 4)            | 4.5                  | 12               | 15     | 18      | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance                                                  | –                    | 10               | 10     | 10      | pF   |
| C <sub>out</sub>                       | Maximum Three-State Output Capacitance<br>(Output in High-Impedance State) | –                    | 15               | 15     | 15      | pF   |

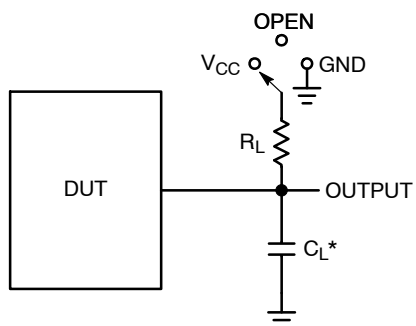
| C <sub>PD</sub> | Power Dissipation Capacitance (Per Buffer)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V |  |  | pF |
|-----------------|---------------------------------------------|-----------------------------------------|--|--|----|
|                 |                                             | 60                                      |  |  |    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

\*Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup>f + I<sub>CC</sub> V<sub>CC</sub>.

## SWITCHING WAVEFORMS

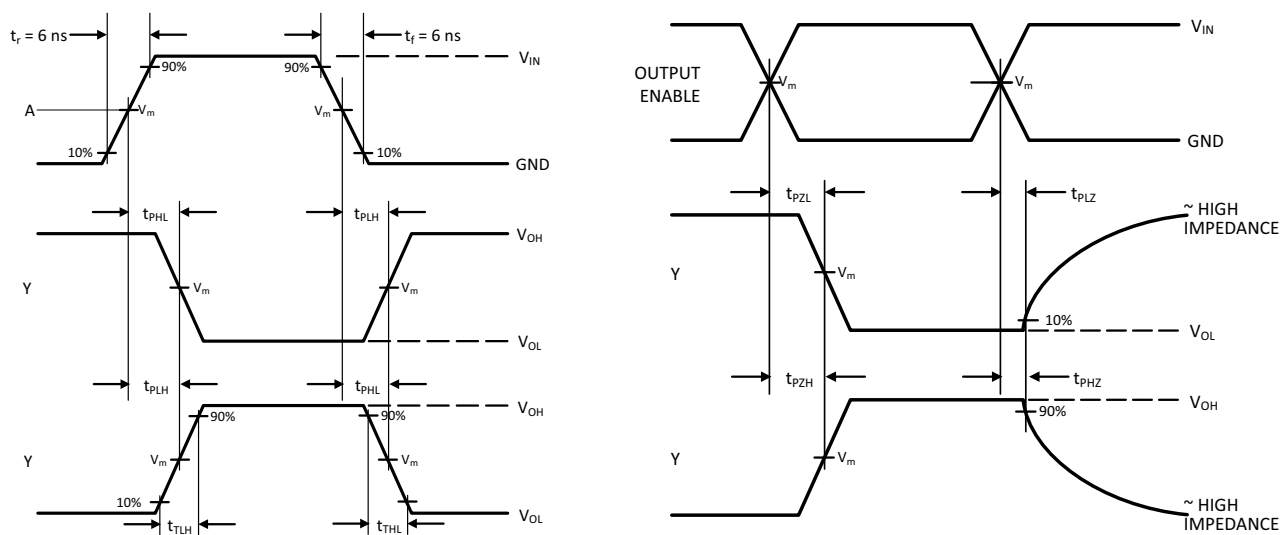
# MC74HC365A, MC74HCT365A



\*C<sub>L</sub> Includes probe and jig capacitance

| Test                                | Switch Position | C <sub>L</sub> | R <sub>L</sub> |
|-------------------------------------|-----------------|----------------|----------------|
| t <sub>PLH</sub> / t <sub>PHL</sub> | Open            | 50 pF          | 1 kΩ           |
| t <sub>PLZ</sub> / t <sub>PZL</sub> | V <sub>CC</sub> |                |                |
| t <sub>PHZ</sub> / t <sub>PZH</sub> | GND             |                |                |

### Figure 3. Test Circuit



| Device      | V <sub>IN</sub> , V | V <sub>m</sub> , V    |
|-------------|---------------------|-----------------------|
| MC74HC365A  | V <sub>CC</sub>     | 50% x V <sub>CC</sub> |
| MC74HCT365A | 3 V                 | 1.3 V                 |

### Figure 4. Switching Waveforms



# MC74HC365A, MC74HCT365A

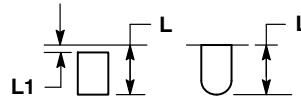
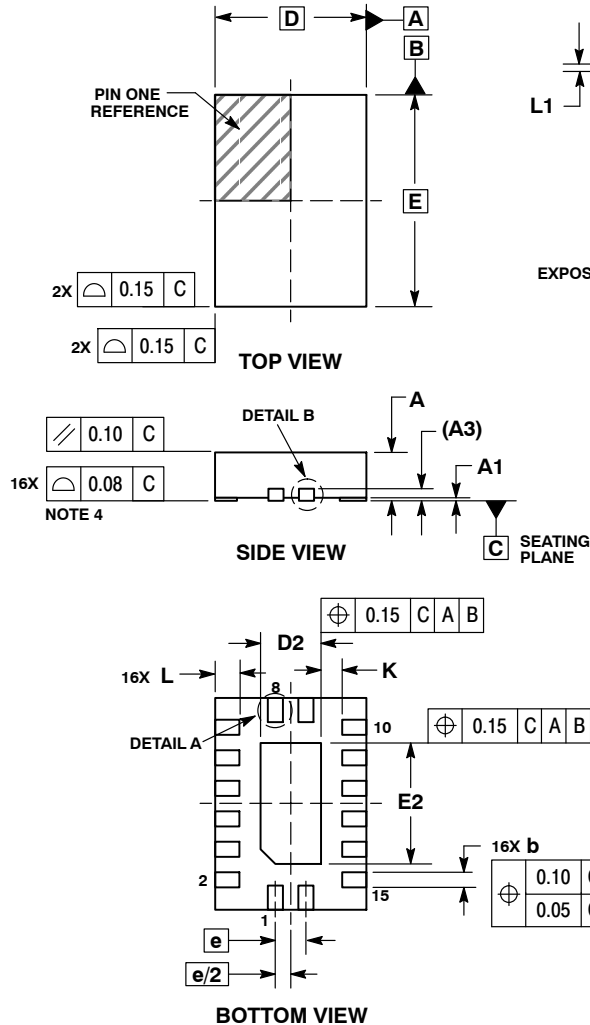
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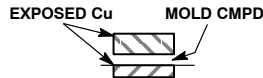
SCALE 2:1

QFN16, 2.5x3.5, 0.5P  
CASE 485AW  
ISSUE O

DATE 11 DEC 2008



**DETAIL A**  
ALTERNATE TERMINAL  
CONSTRUCTIONS



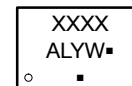
**DETAIL B**  
ALTERNATE  
CONSTRUCTIONS

### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.80 | 1.00 |
| A1          | 0.00 | 0.05 |
| A3          | 0.20 | REF  |
| b           | 0.20 | 0.30 |
| D           | 2.50 | BSC  |
| D2          | 0.85 | 1.15 |
| E           | 3.50 | BSC  |
| E2          | 1.85 | 2.15 |
| e           | 0.50 | BSC  |
| K           | 0.20 | ---  |
| L           | 0.35 | 0.45 |
| L1          | ---  | 0.15 |

### GENERIC MARKING DIAGRAM\*

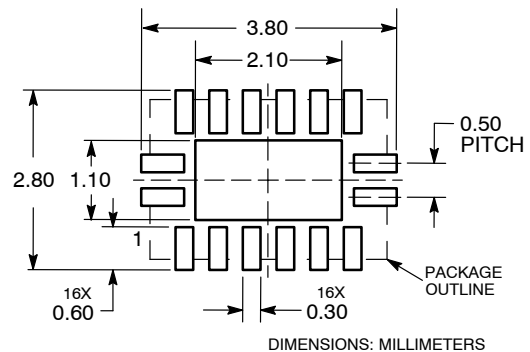


- XXXX = Specific Device Code  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

### RECOMMENDED SOLDERING FOOTPRINT\*



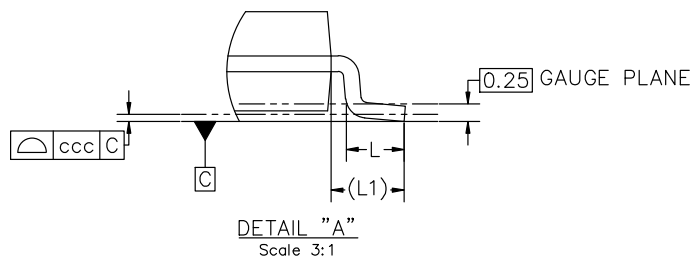
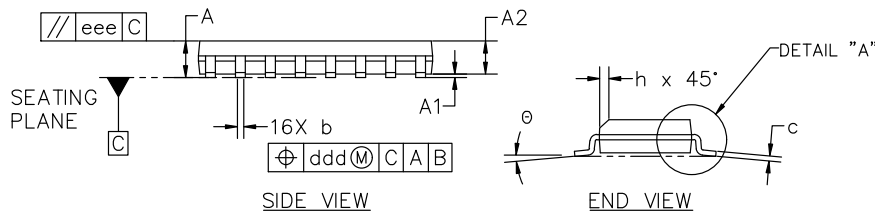
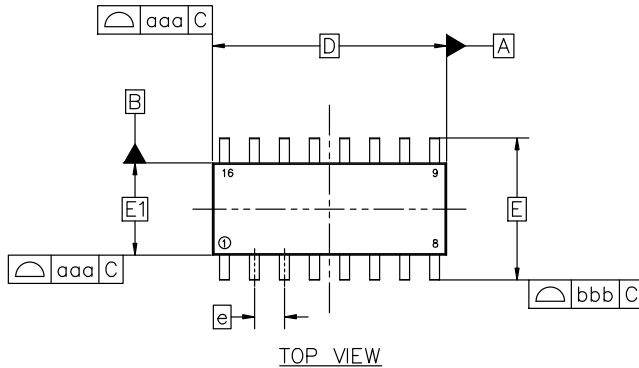
\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.


**SOIC-16 9.90x3.90x1.37 1.27P**  
**CASE 751B**  
**ISSUE M**

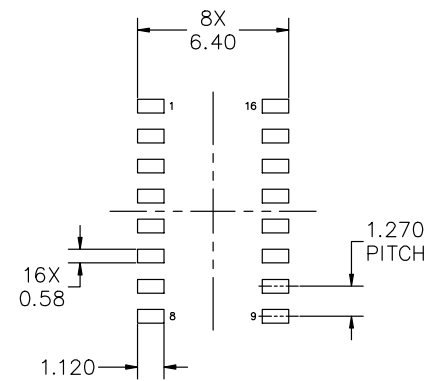
DATE 18 OCT 2024

## NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. DIMENSION IN MILLIMETERS. ANGLE IN DEGREES.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15mm PER SIDE.
5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127mm TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.



| MILLIMETERS                    |          |      |      |
|--------------------------------|----------|------|------|
| DIM                            | MIN      | NOM  | MAX  |
| A                              | 1.35     | 1.55 | 1.75 |
| A1                             | 0.10     | 0.18 | 0.25 |
| A2                             | 1.25     | 1.37 | 1.50 |
| b                              | 0.35     | 0.42 | 0.49 |
| c                              | 0.19     | 0.22 | 0.25 |
| D                              | 9.90 BSC |      |      |
| E                              | 6.00 BSC |      |      |
| E1                             | 3.90 BSC |      |      |
| e                              | 1.27 BSC |      |      |
| h                              | 0.25     | ---  | 0.50 |
| L                              | 0.40     | 0.83 | 1.25 |
| L1                             | 1.05 REF |      |      |
| θ                              | 0°       | ---  | 7°   |
| TOLERANCE OF FORM AND POSITION |          |      |      |
| aaa                            | 0.10     |      |      |
| bbb                            | 0.20     |      |      |
| ccc                            | 0.10     |      |      |
| ddd                            | 0.25     |      |      |
| eee                            | 0.10     |      |      |



\*FOR ADDITIONAL INFORMATION ON OUR  
PB-FREE STRATEGY AND SOLDERING DETAILS,  
PLEASE DOWNLOAD THE onsemi SOLDERING  
AND MOUNTING TECHNIQUES REFERENCE  
MANUAL, SOLDERM/D

|                         |                                     |                                                                                                                                                                                     |
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| <b>DESCRIPTION:</b>     | <b>SOIC-16 9.90X3.90X1.37 1.27P</b> | <b>PAGE 1 OF 2</b>                                                                                                                                                                  |

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SOIC-16 9.90x3.90x1.37 1.27P  
CASE 751B  
ISSUE M

DATE 18 OCT 2024

GENERIC  
MARKING DIAGRAM\*

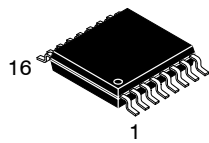


XXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
Y = Year  
WW = Work Week  
G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

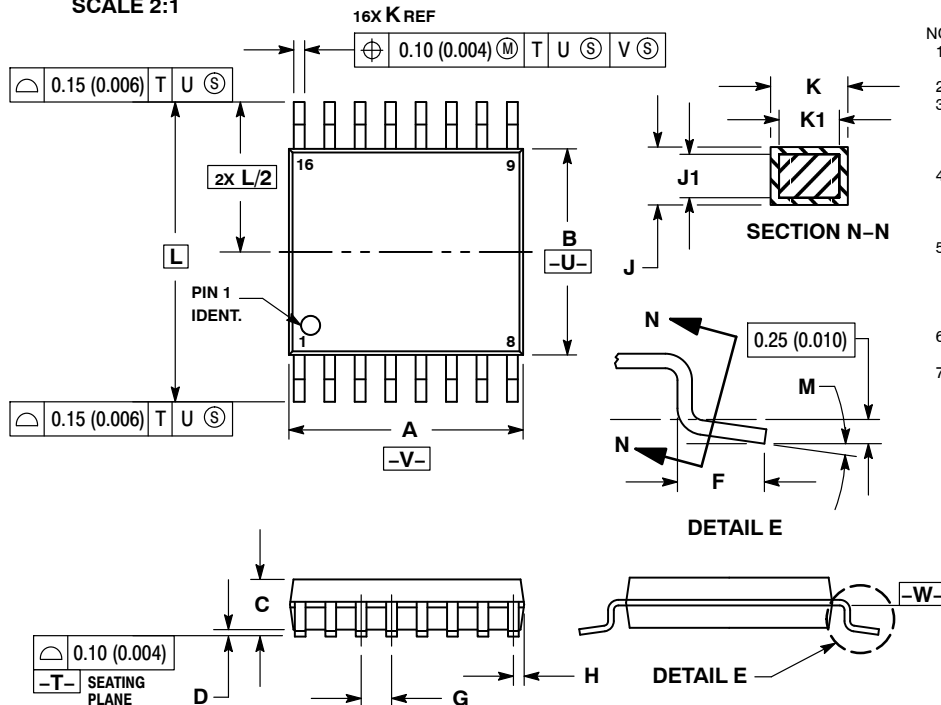
|                                                                                                                                                                                                                                                                                         |                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                                                             |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| STYLE 1:<br>PIN 1. COLLECTOR<br>2. BASE<br>3. EMITTER<br>4. NO CONNECTION<br>5. EMITTER<br>6. BASE<br>7. COLLECTOR<br>8. COLLECTOR<br>9. BASE<br>10. EMITTER<br>11. NO CONNECTION<br>12. EMITTER<br>13. BASE<br>14. COLLECTOR<br>15. EMITTER<br>16. COLLECTOR                           | STYLE 2:<br>PIN 1. CATHODE<br>2. ANODE<br>3. NO CONNECTION<br>4. CATHODE<br>5. CATHODE<br>6. NO CONNECTION<br>7. ANODE<br>8. CATHODE<br>9. CATHODE<br>10. ANODE<br>11. NO CONNECTION<br>12. CATHODE<br>13. CATHODE<br>14. NO CONNECTION<br>15. ANODE<br>16. CATHODE | STYLE 3:<br>PIN 1. COLLECTOR, DYE #1<br>2. BASE, #1<br>3. EMITTER, #1<br>4. COLLECTOR, #1<br>5. COLLECTOR, #2<br>6. BASE, #2<br>7. EMITTER, #2<br>8. COLLECTOR, #2<br>9. COLLECTOR, #3<br>10. BASE, #3<br>11. EMITTER, #3<br>12. COLLECTOR, #3<br>13. COLLECTOR, #4<br>14. BASE, #4<br>15. EMITTER, #4<br>16. COLLECTOR, #4                                                                                         | STYLE 4:<br>PIN 1. COLLECTOR, DYE #1<br>2. COLLECTOR, #1<br>3. COLLECTOR, #2<br>4. COLLECTOR, #2<br>5. COLLECTOR, #3<br>6. COLLECTOR, #3<br>7. COLLECTOR, #4<br>8. COLLECTOR, #4<br>9. BASE, #4<br>10. EMITTER, #4<br>11. BASE, #3<br>12. EMITTER, #3<br>13. BASE, #2<br>14. EMITTER, #2<br>15. BASE, #1<br>16. EMITTER, #1 |
| STYLE 5:<br>PIN 1. DRAIN, DYE #1<br>2. DRAIN, #1<br>3. DRAIN, #2<br>4. DRAIN, #2<br>5. DRAIN, #3<br>6. DRAIN, #3<br>7. DRAIN, #4<br>8. DRAIN, #4<br>9. GATE, #4<br>10. SOURCE, #4<br>11. GATE, #3<br>12. SOURCE, #3<br>13. GATE, #2<br>14. SOURCE, #2<br>15. GATE, #1<br>16. SOURCE, #1 | STYLE 6:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. CATHODE<br>4. CATHODE<br>5. CATHODE<br>6. CATHODE<br>7. CATHODE<br>8. CATHODE<br>9. ANODE<br>10. ANODE<br>11. ANODE<br>12. ANODE<br>13. ANODE<br>14. ANODE<br>15. ANODE<br>16. ANODE                                 | STYLE 7:<br>PIN 1. SOURCE N-CH<br>2. COMMON DRAIN (OUTPUT)<br>3. COMMON DRAIN (OUTPUT)<br>4. GATE P-CH<br>5. COMMON DRAIN (OUTPUT)<br>6. COMMON DRAIN (OUTPUT)<br>7. COMMON DRAIN (OUTPUT)<br>8. SOURCE P-CH<br>9. SOURCE P-CH<br>10. COMMON DRAIN (OUTPUT)<br>11. COMMON DRAIN (OUTPUT)<br>12. COMMON DRAIN (OUTPUT)<br>13. GATE N-CH<br>14. COMMON DRAIN (OUTPUT)<br>15. COMMON DRAIN (OUTPUT)<br>16. SOURCE N-CH |                                                                                                                                                                                                                                                                                                                             |

|                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |                              |                                                                                                                                                                                     |
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TSSOP-16 WB  
CASE 948F  
ISSUE B

DATE 19 OCT 2006

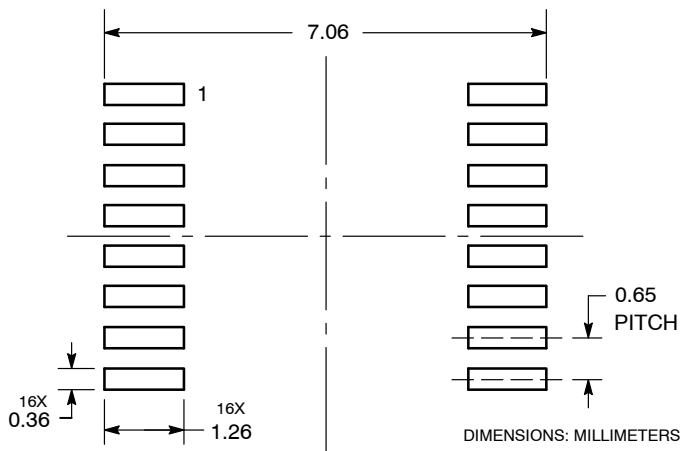


NOTES:

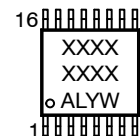
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 4.90        | 5.10 | 0.193     | 0.200 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | ---         | 1.20 | ---       | 0.047 |
| D   | 0.05        | 0.15 | 0.002     | 0.006 |
| F   | 0.50        | 0.75 | 0.020     | 0.030 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.18        | 0.28 | 0.007     | 0.011 |
| J   | 0.09        | 0.20 | 0.004     | 0.008 |
| J1  | 0.09        | 0.16 | 0.004     | 0.006 |
| K   | 0.19        | 0.30 | 0.007     | 0.012 |
| K1  | 0.19        | 0.25 | 0.007     | 0.010 |
| L   | 6.40 BSC    |      | 0.252 BSC |       |
| M   | 0°          | 8°   | 0°        | 8°    |

RECOMMENDED  
SOLDERING FOOTPRINT\*



GENERIC  
MARKING DIAGRAM\*



- XXXX = Specific Device Code  
A = Assembly Location  
L = Wafer Lot  
Y = Year  
W = Work Week  
G or ■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

|                  |             |                                                                                                                                                                                  |
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| DESCRIPTION:     | TSSOP-16    | PAGE 1 OF 1                                                                                                                                                                      |

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